

FICCI PACKAGING INDUSTRY DELEGATION TO UNITED STATES September 23-28, 2013

Pack Expo - Las Vegas-September 23-26,2013
Chicago-September 27-28,2013



FICCI , with support of US Commercial Service in India and US, is pleased to invite you to be a part of the Indian delegation to PACKEXPO-Las Vegas, the world's largest packaging and processing event that showcases state-of-the-art materials, machinery and methods for packaging and processing from leading companies around the world.

The second leg (optional) of visit would be to Chicago , the industrial heartland of United States. At Chicago, the site visits to prominent US Companies will be arranged for delegation.

Features of PACK EXPO

Pack Expo-Las Vegas will feature Industry-Specific pavillions to showcase the technological applications and solutions geared towards specific industries:Brand Zone, Processing Zone,Pharmaceutical Pavillion, Confectionary Pavillion,The Re-usable Packaging Pavillion.

For more information, log on to www.packexpo.com

Benefits of joining the delegation

Professionals from Indian Packaging industry will benefit in the following ways:

- B2B matchmaking services at PACK EXPO
- Complimentary registration at PACK EXPO and networking events
- Site visits to see latest technologies and equipments in action

If you would like to be a part of this global event and explore the wide range of opportunities, please register with us at the earliest.

Deadline to Register: August 14, 2013

Registration fee: Rs 20,000 (plus 12.36 Service tax)

**All interested companies will have to be pre-qualified to avail the services of USFCS and visa facilitation.*

To Register, please contact:

Mr Sandip Samaddar, Head-US & Canada Division
sandip.samaddar@ficci.com
Ph:011-23765320/23487254; M:+91-9810311474

